







END VIEW OF MATED CONNECTORS

| DIM. "A" | RECPT. ASSY. P/N | | | | |
|----------|------------------|--|--|--|--|
| 17 | 55701 | | | | |
| 22 | 10032376 | | | | |
| 27 | 55733 | | | | |

NOTES CONTINUED

- 6 SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.
- FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEADFREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE, LEADFREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.

8)THIS PRODUCT MEETS THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008. PRODUCT MEETING WITH THES DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION.

| FCì | ≝ GIG-Array, PLUG ASSEMBLY = 12mm, 296 SIGNAL POSITION | dwg no | 100268 | 04 | Rev. C |
|--------------|---|--------|----------|------------|-----------|
| catalog no - | | | CUSTOMER | sheet 4 of | 4 |

NOTES:

-) MAT'L: HOUSING: LCP CONTACT: COPPER ALLOY PLATING (CONTACT): AU OVER NI. UL RATING: 94 V-0
- 2) SOLDER BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- (3) MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.
- (4) CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T ARE SINGLE BEAM CONTACTS, TYPICALLY USED AS GROUND PINS. (NOTE: CONTACTS IN ROWS J & K ARE TIED TOGETHER [COMMONED])
- (5) CONTACTS IN ROWS B,D,F,H,L,N,Q AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.

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